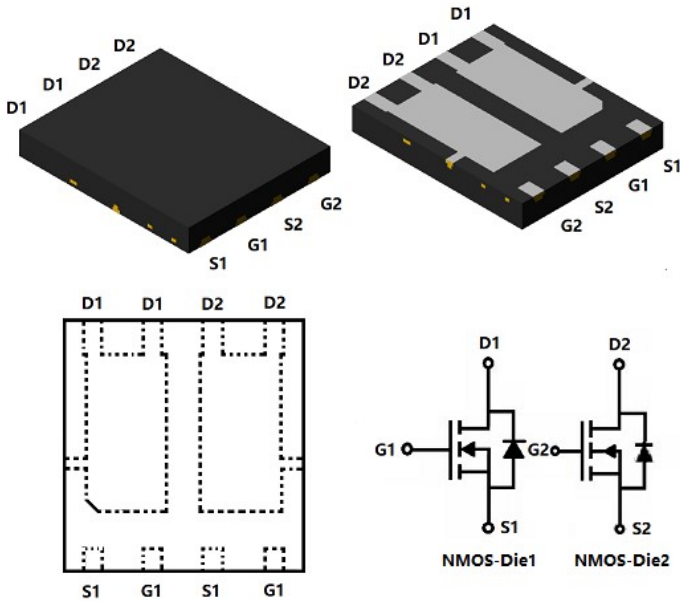


N-Channel Enhancement Mode Field Effect Transistor

DFN5060-8L



Product Summary

NMOS(Die1)	
• V_{DS}	100V
• I_D	20A
• $R_{DS(ON)}$ (at $V_{GS}=10V$)	<22 mohm
• $R_{DS(ON)}$ (at $V_{GS}=4.5V$)	<27 mohm
NMOS(Die2)	
• V_{DS}	100V
• I_D	20A
• $R_{DS(ON)}$ (at $V_{GS}=10V$)	<22 mohm
• $R_{DS(ON)}$ (at $V_{GS}=4.5V$)	<27 mohm

General Description

- Split gate trench MOSFET technology
- High density cell design for low $R_{DS(ON)}$
- High Speed switching

Applications

- DC-DC Converters
- Power management functions
- Industrial and Motor Drive application

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	N-Die1	N-Die2	Unit
Drain-source Voltage		V_{DS}	100	100	V
Gate-source Voltage		V_{GS}	± 20	± 20	V
Drain Current	$T_C=25^\circ\text{C}$	I_D	20	20	A
	$T_C=70^\circ\text{C}$		12.5	12.5	
Pulsed Drain Current ^A		I_{DM}	80	80	A
Avalanche energy ^B		E_{AS}	64	64	mJ
Total Power Dissipation	$T_C=25^\circ\text{C}$	P_D	17	17	W
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	-55~+150	$^\circ\text{C}$

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^D	$t \leq 10\text{S}$	$R_{\theta JA}$	30	40	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Ambient ^D	Steady-State		60	75	
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	6.2	7.5	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJGD20G10A	F1	YJGD20G10A	5000	10000	100000	13" reel



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■ NMOS(Die1/Die2) Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=100V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.8	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=15A$		17	22	m Ω
		$V_{GS}=4.5V, I_D=7A$		21	27	
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.96	1.3	V
Maximum Body-Diode Continuous Current	I_S				20	A
Gate Resistance	R_g	$f=1\text{MHz}$		1.2		Ω
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=50V, V_{GS}=0V, f=1\text{MHz}$		1051		pF
Output Capacitance	C_{oss}			399		
Reverse Transfer Capacitance	C_{rss}			18		
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=10V, V_{DS}=50V, I_D=25A$		16		nC
Gate-Source Charge	Q_{gs}			5.6		
Gate-Drain Charge	Q_{gd}			2.4		
Reverse Recovery Chrage	Q_{rr}	$I_F=20A, di/dt=100A/us$		42		ns
Reverse Recovery Time	t_{rr}			39.8		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DD}=50V, I_D=4.0A$ $R_{GEN}=3.0\Omega$		39.2		ns
Turn-on Rise Time	t_r			11		
Turn-off Delay Time	$t_{D(off)}$			53.2		
Turn-off fall Time	t_f			15.8		
Peak reverse recovery corrent	I_{rm}	$I_F=4A, di/dt=100A/us$		3		A

A. Repetitive rating; pulse width limited by max. junction temperature.

B. $V_{DD}=50V, R_G=25\Omega, L=0.5\text{mH}, I_D=16A$.

C. Pd is based on max. junction temperature, using junction-case thermal resistance.

D. The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation PDSM is based on $R_{\theta JA} \leq 10s$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.



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■ NMOS(Die1/Die2) Typical Performance Characteristics

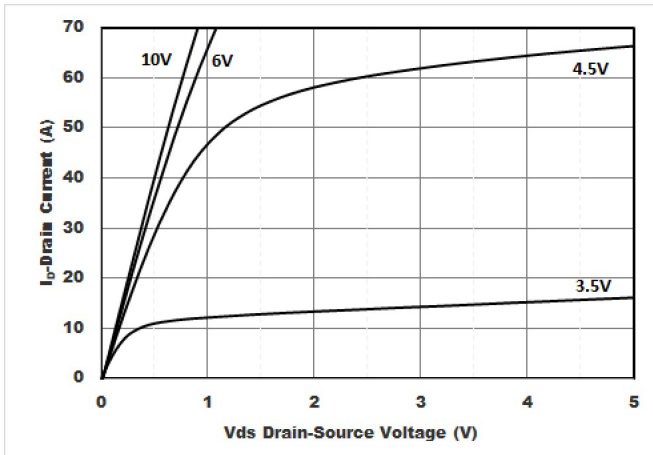


Figure1. Output Characteristics

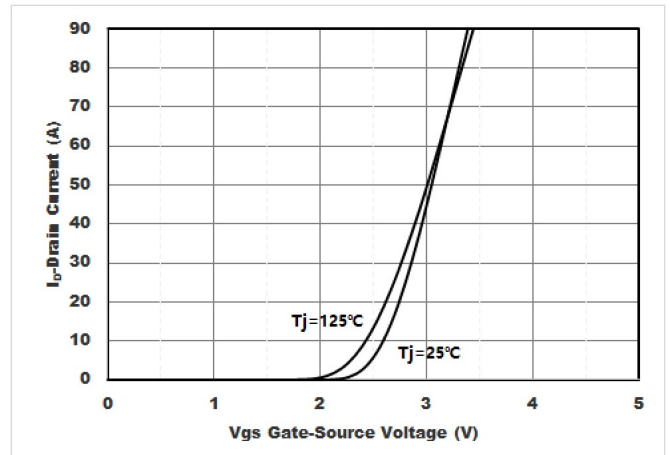


Figure2. Transfer Characteristics

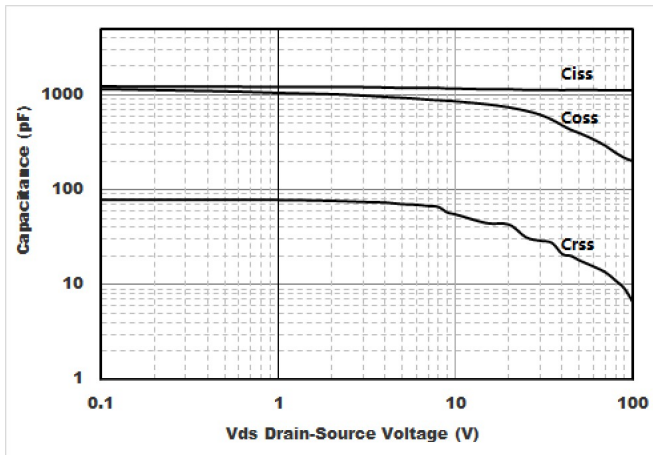


Figure3. Capacitance Characteristics

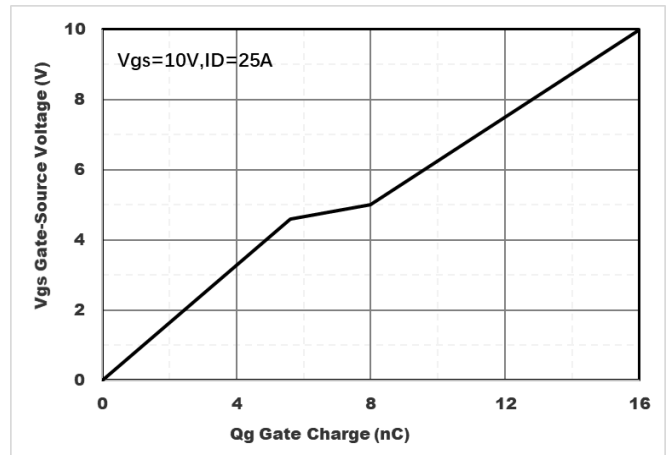


Figure4. Gate Charge

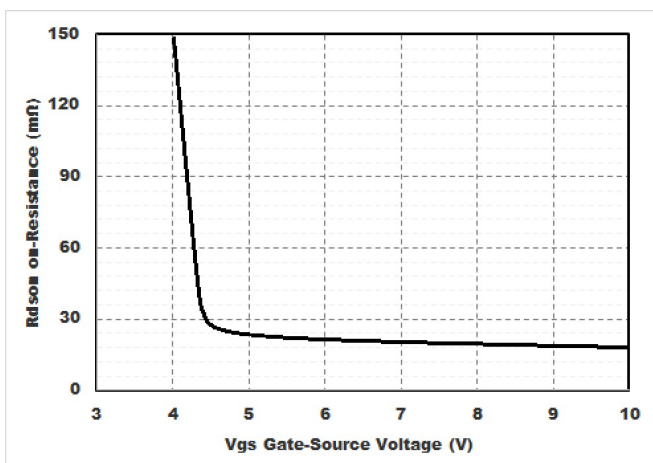


Figure5. : On-Resistance vs. Gate to Source Voltage

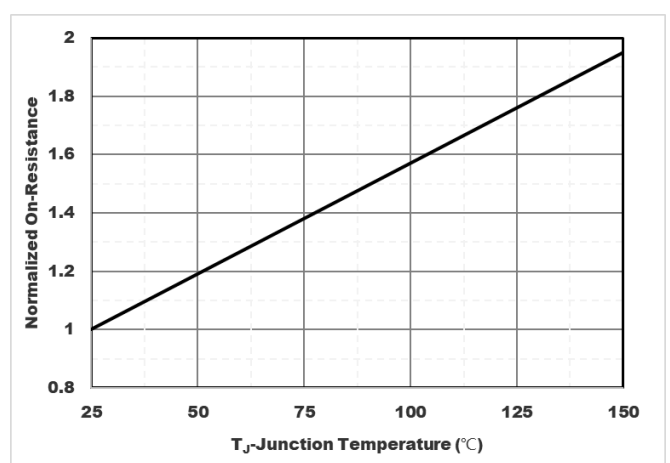


Figure6. Normalized On-Resistance



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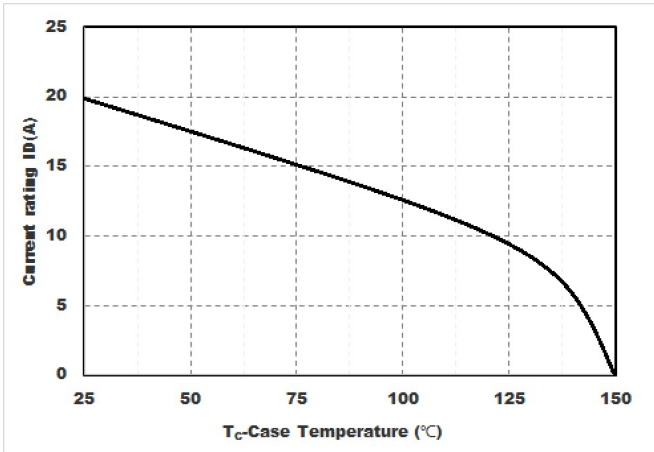


Figure7. Drain current

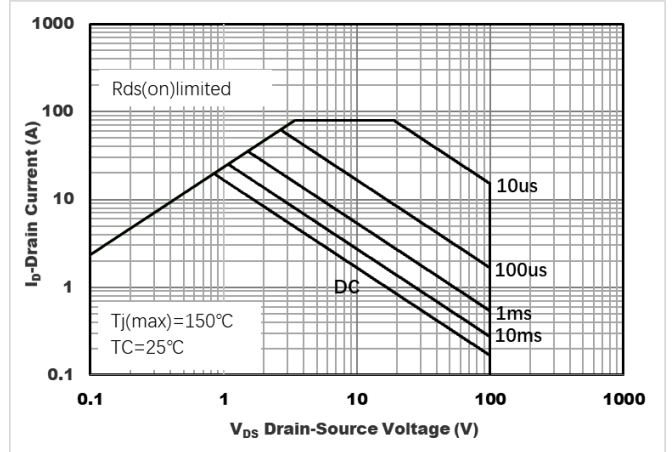


Figure8.Safe Operation Area

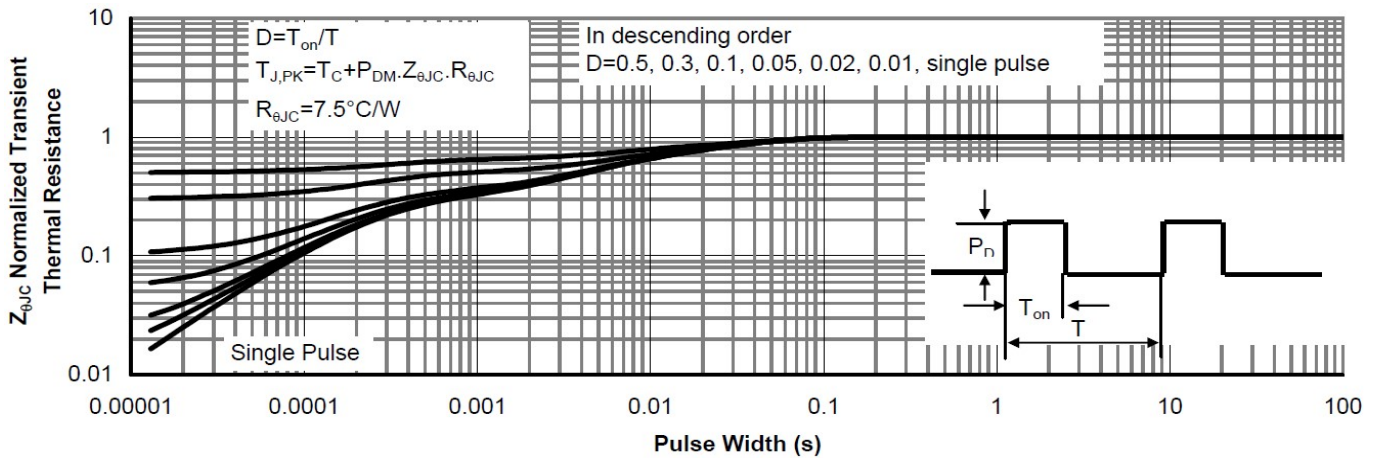
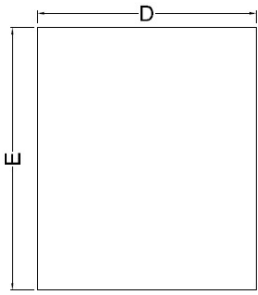


Figure9.Normalized Maximum Transient thermal impedance

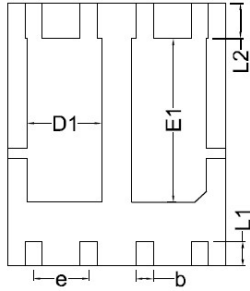


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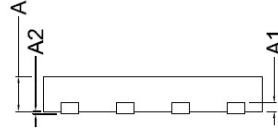
DFN5060-8L Package information



Top View
正面视图

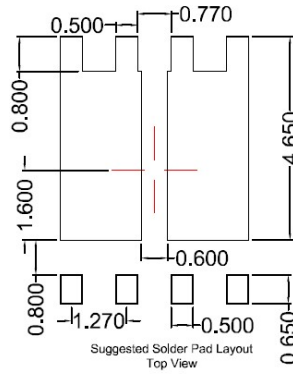


Bottom View
背面视图



Side View
侧面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	4.90	5.00	5.10
E	5.90	6.00	6.10
A	0.70	0.80	0.90
A1	0.20 BSC		
A2			0.10
D1	1.60	1.70	1.80
E1	3.65	3.75	3.85
L1	0.45	0.55	0.65
L2	080 BSC		
b	0.30	0.40	0.50
e	1.27 BSC		



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: ± 0.10 mm.
 3. The pad layout is for reference purposes only.



YJGD20G10A

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